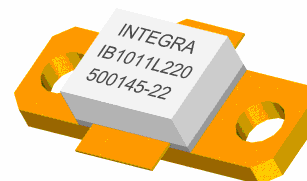


L-Band Avionics Transistor

The high power pulsed avionics transistor part number IB1011L220 is designed for L-Band avionics systems operating at 1030 and 1090 MHz. While operating in class C mode under Mode S – ELM pulse burst conditions at $V_{CC} = 48V$, this common base device supplies a minimum of 220 watts of peak pulse power. It utilizes a low loss internal input impedance matching structure to yield maximum device gain and to ease the implementation of external matching circuitry. The new generation bipolar transistor geometry utilizes a gold metallization system to achieve maximum reliability. Emitter ballast resistance is incorporated on the active cell for optimum thermal distribution and maximum reliability. All devices are 100% screened for large signal RF parameters.



Silicon Bipolar

- Ultra-high f_T

Class C Operation

- High Efficiency

Common Base Configuration

- Single Power Supply

Gold Metal

- Maximum Reliability

Emitter Ballasting

- Optimum Thermal Distribution

Internal Impedance Matching

- Ease of Use
- Ultra-low Loss Design

BeO Package

- Unmatched Thermal Reliability

RF Test Fixture

- Broadband
- Matched to 500
- Long-term Correlation
- 100% Device RF Screening
- No External Tuning Allowed
- Micro-strip structure on soft pc board with dielectric constant 10.5

PRELIMINARY DATA

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Device	Freq (MHz)	V_{CC} (V)	P_{IN} (W)	IRL (dB)	P_{OUT} (W)	G_P (dB)	I_c (A)	η_c (%)	Droop (dB)	P_{OUT} @ P_{IN+1dB} (W)
D4327-1	1030	48	27	22	231	9.3	8.44	57.0	-0.30	245
D4327-3	1030	48	27	18	235	9.4	8.37	58.5	-0.25	251

Pulse Format = Mode S - ELM – 32 μs on/18 μs off x 48, overall duty cycle 6.4%

Power measurements made using Boonton 4500 Peak Power Analyzer

MAXIMUM RATINGS

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
BD	Collector-Emitter Voltage	V_{CES}	--	85	V	--
BD	Emitter-Base Voltage	V_{EBO}	--	2	V	--
BD	Storage Temperature Range	T_{STG}	-55	+150	°C	--
BD	Operating Junction Temperature Range	T_J	-55	+200	°C	--
Note	Screen 'BD' = parameter qualified By Design.					

THERMAL CHARACTERISTICS

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
BD	Thermal Resistance	$R_{TH(JC)}$	--	0.88	°C/W	$V_{CC}=48V$, Pulse format=1000us, 6.4%, $T_F=25\pm5^\circ C$, $P_N=27W$, $P_{out}=220W$, $N_C=52\%$
Note	Screen 'BD' = parameter qualified By Design.					

PROCESSING SPECIFICATIONS

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
100%	DC Wafer Probe	--	--	--	--	Per Integra specification.
Q1	Wafer DC and RF Qualification	--	--	--	--	Per Integra specification.
LM	Wire Bond Strength	--	--	--	--	Line monitor per Integra specification.
100%	Pre-cap visual inspection	--	--	--	--	Per Integra specification
100%	Gross leak test	--	--	--	--	MIL-STD-750D, Method 1071, Test Condition C
Note	Screen 'Q1' = parameter is qualified by assembly and test of 3 pieces minimum per wafer.					
Note	Screen 'LM' = parameter is qualified by assembly line monitor.					

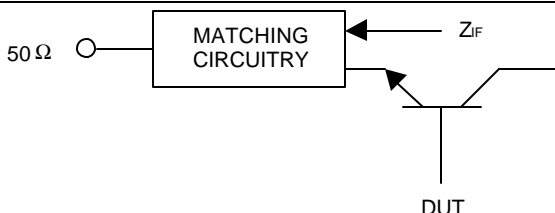
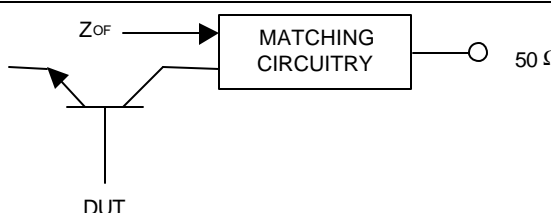
DC ELECTRICAL CHARACTERISTICS

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
100%	Collector-Emitter Breakdown Voltage	BV_{CES}	85	--	V	$I_C = 40mA$, $V_{BE} = 0V$, $T_F = 25\pm5^\circ C$.
100%	Zero Base Voltage Collector Leakage Current	I_{CES}	--	20	mA	$V_{CE} = 48V$, $V_{BE} = 0V$, $T_F = 25\pm5^\circ C$.
100%	DC Current Gain	H_{FE}	10	100	--	$V_{CE} = 5V$, $I_C = 0.2A$, $T_F = 25\pm5^\circ C$.

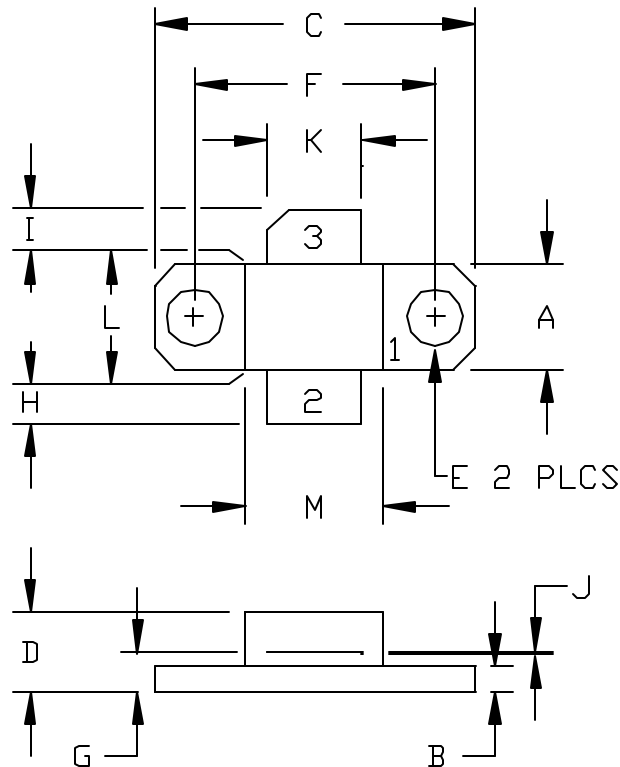
RF ELECTRICAL CHARACTERISTICS

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
100%	Input Return Loss	IRL	10	--	dB	$V_{CC}=48V$, $P_{IN}=27W$, Pulse = Note 2, $T_F=25\pm 5^\circ C$, $F=F1$.
100%	Maximum Overdrive	$P_{IN(MAX)}$		33	W	$V_{CC}=48V$, Pulse = Note 2, $T_F=25\pm 5^\circ C$, $F=F1$.
100%	Power Gain	G_P	9.0	10.5	dB	$V_{CC}=48V$, $P_{IN}=27W$, Pulse = Note 2, $T_F=25\pm 5^\circ C$, $F=F1$
100%	Collector Efficiency ($P_o/I_c/V_{CC}$)	η_c	52	--	%	$V_{CC}=48V$, $P_{IN}=27W$, Pulse = Note 2, $T_F=25\pm 5^\circ C$, $F=F1$.
100%	Pulse Amplitude Droop	D	--	0.5	dB	$V_{CC}=48V$, $P_{IN}=27W$, Pulse = Note 2, $T_F=25\pm 5^\circ C$, $F=F1$.
100%	Stability into 1.5:1 VSWR	VSWR-S	--	--	--	$V_{CC}=48V$, $P_{IN}=27W$, Pulse = Note 2, $T_F=25\pm 5^\circ C$, $F=F1$. Rotate 1.5:1 output VSWR through 360° phase. No oscillatory or pulse break-up characteristics allowed on detected output pulse.
100%	Load Mismatch Tolerance	LMT	2:1	--	--	$V_{CC}=48V$, $P_{IN}=27W$, Pulse = Note 2, $T_F=25\pm 5^\circ C$, $F=F1$. Rotate 3:1 output VSWR through 360° phase. Survival.
BD	Pulse Risetime	RT	--	80	ns	$V_{CC}=48V$, $P_{IN}=27W$, Pulse = Note 2, $T_F=25\pm 5^\circ C$, $F=F1$. Measure between 10% and 90% detected power points.
Note 1	F1 = 1030 MHz.					
Note 2	Pulse format = Mode S - ELM (32µs on / 18µs off x 48, overall duty cycle 6.4%)					
Note 3	T_F = Device flange temperature.					
Note 4	Screen 'BD' = parameter qualified By Design.					

RF TEST FIXTURE IMPEDANCE CHARACTERISTICS

Frequency (MHz)	Z_{IF} (W)	Z_{OF} (W)
1030	TBD	TBD
Impedance Definition		

PACKAGE DIMENSIONAL OUTLINE DRAWING



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.243	0.253	6.17	6.43
B	0.055	0.065	1.40	1.65
C	0.739	0.749	18.77	19.02
D	0.178	0.188	4.52	4.78
E	0.125	0.135	3.18	3.43
F	0.555	0.565	14.10	14.35
G	0.082	0.092	2.08	2.34
H	0.080	0.150	2.79	3.56
I	0.080	0.150	2.03	2.54
J	0.004	0.006	0.10	0.15
K	0.215	0.225	5.46	5.72
L	0.245	0.255	6.22	6.48
M	0.315	0.325	8.00	8.26

PIN SCHEDULE	
1	BASE
2	EMITTER
3	COLLECTOR

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DOCUMENT NUMBER:
IB1011L220

SHEET NAME:
06-OUTLINE

REV:
NC

REV:
NC

RF TEST FIXTURE

TBD

ASSEMBLY AND PARTS LIST

RF TEST FIXTURE

TBD

CIRCUIT DIMENSIONS

RF TEST FIXTURE

TBD

ELECTRICAL SCHEMATIC

DEFINITIONS

Data Sheet Status	
Proposed Specification	This data sheet contains proposed specifications.
Preliminary Specification	This data sheet contains specifications based on preliminary measurements and data.
Product Specification	This data sheet contains final product specifications.
Maximum Ratings	
Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only. Operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability.	

WARNING

Product and environmental safety - toxic materials
This product contains beryllium oxide. The product is entirely safe provided that the BeO base is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with general or domestic waste.

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